SDLS198

02423, JANUARY 1981-REVISED MARCH 1988

- 4-Bit Counters/Registers
- Multiplexed Outputs for Counter or Latched Data
- 3-State Outputs Drive Bus Lines Directly
- 'LS690 . . . Decade Counter, Direct Clear 'LS691 . . . Binary Counter, Direct Clear 'LS693 . . . Binary Counter, Synchronous Clear

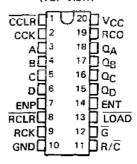
description

These low-power Schottky LSI devices incorporate synchronous counters, four-bit D-type registers, and quadruple two-line to one-line multiplexers with three-state outputs in a single 20-pin package. The counters can be programmed from the data inputs and have enable P inputs and enable T inputs and a ripple-carry output for easy expansion. The register/counter select input, R/C, selects the counter when low or the register when high for the three-state outputs, QA, QB, QC, and QD. These outputs are rated at 12 and 24 milliamperes (54LS/74LS) for good bus-driving performance.

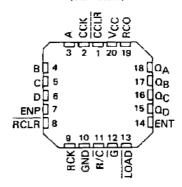
Individual clock and clear inputs are provided for both the counter and the register. Both clock inputs are positive-edge triggered: The clear line is active low and is asynchronous on the 'LS690 and 'LS691, synchronous on the 'LS693. Loading of the counter is accomplished when \overline{LOAD} is taken low and a positive-transition occurs on the counter clock CCK.

Expansion is easily accomplished by connecting RCO of the first stage to ENT of the second state, etc. All ENP inputs can be tied common and used as master enable or disable control.

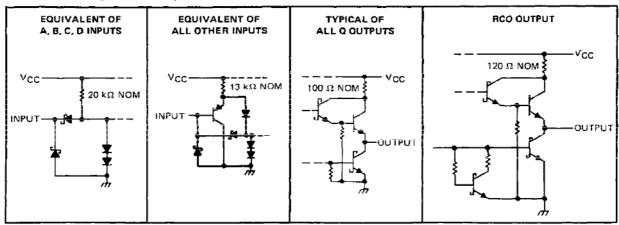
SN54LS690, SN54LS691, SN54LS693...J PACKAGE SN74LS690, SN74LS691, SN74LS693...DW OR N PACKAGE (TOP VIEW)



\$N54L\$690, \$N54L\$691, \$N54L\$693 . . . FK PACKAGE (TOP VIEW)



schematics of inputs and outputs



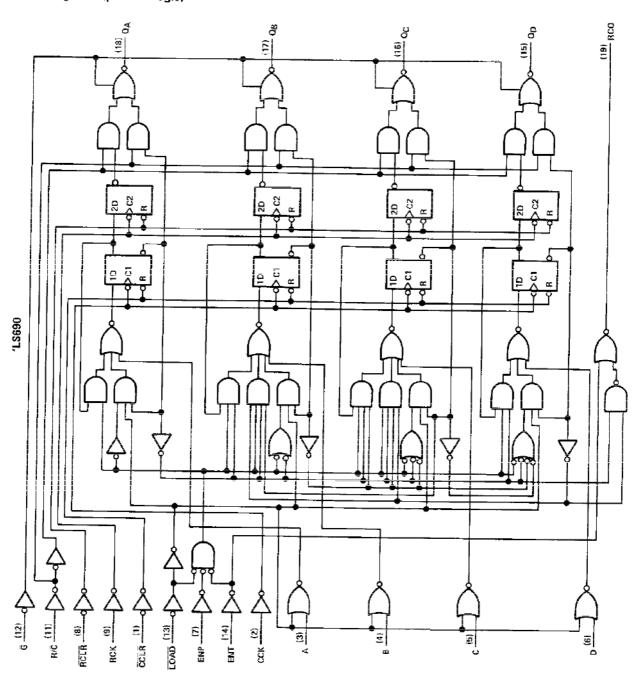
PRODUCTION DATA decuments centein information current as of publication data. Products conform to specifications per the terms of Taxas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



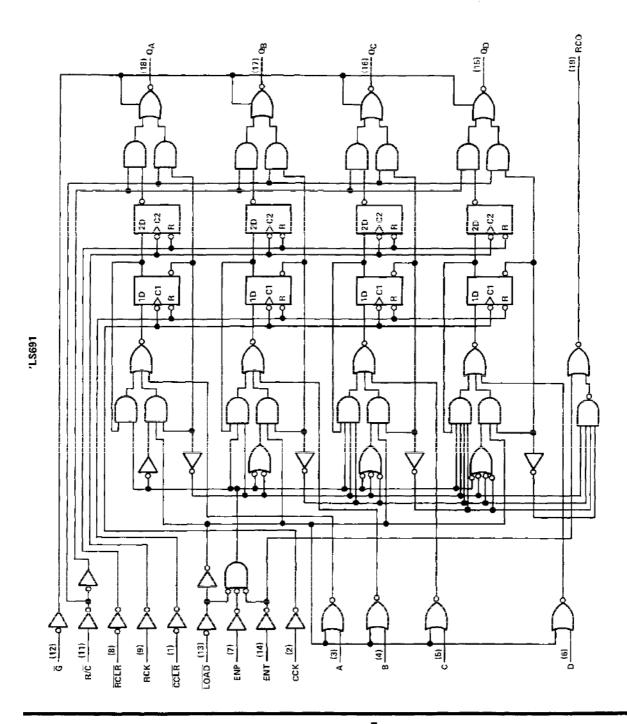
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SN54LS690, SN74LS690 SYNCHRONOUS COUNTERS WITH OUTPUT REGISTERS AND MULTIPLEXED 3-STATE OUTPUTS

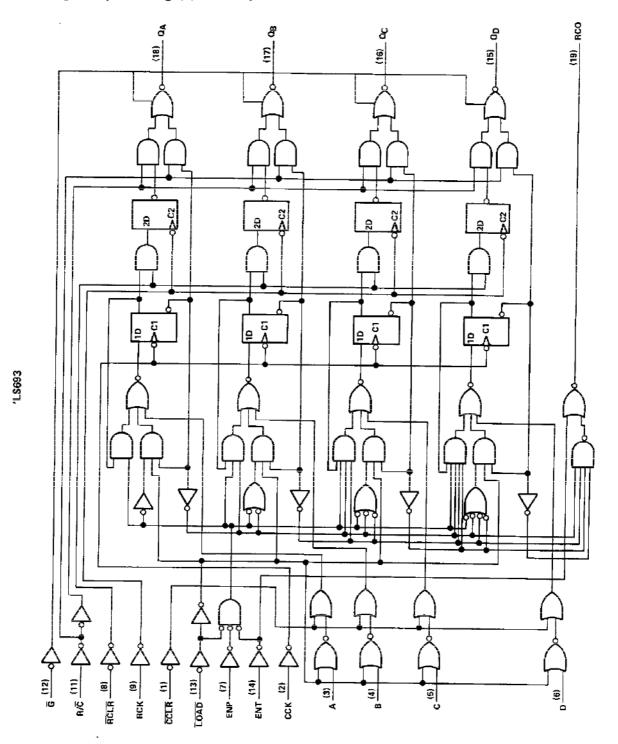
logic diagrams (positive logic)



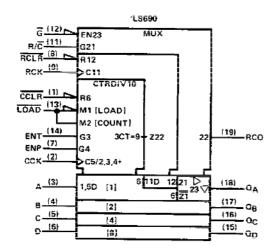
logic diagrams (positive logic) (continued)

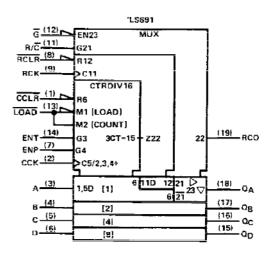


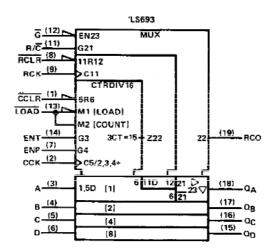
logic diagrams (positive logic) (continued)



logic symbols†







[†]These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

SN74LS690, SN74LS691, SN74LS693 0°C to 70°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

					SN54LS'		SN74LS'			UNIT	
				MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
Vcc	Supply voitage)		4.5	5	5.5	4.75	5	5.25	V	
VIH	High-level inpu	ut voltage		2			2			ν	
VIL	Low-level inpu	it voltage				0.7			0.8	V	
'он	High-level output current		Q			- 1			- 2.6	mΑ	
			RCO			- 0.4			- 0.4	mΑ	
loL	Low-level output current		Q			12 !			24	mΑ	
			RCÓ			4			8	mA	
^f clock	Clock frequency		CCK_	0		20	0		20	MHz	
			RCK	0		20	0		20	MHz	
	Pulse duration (LS690, 'LS691		CCK high or low	25			25				
			RCK high or low	25			25			ns	
^t w			RCLR low	20			20				
		23030, 23031	CCLR low	20	20						
	Setup time		A thru D	30			30				
•			ENP or ENT	30			30]	
t _{su}	before CCK 1		LOAD	30			30			ns	
	DOTOTO GOIX	'LS693	CCLR 1	40			40				
		1LS690, 1LS691	CCLR ↑ inactive	25			25				
^t su	Setup time before RCK 1		CCK † (see Note 2)	30			30				
		'LS690, 'LS691	RCLR † inactive	25			25			ns	
		'LS693	BCFB 1	20			20				
th	Hold time	Any input from CCi	C t or RCK t	0			0			ns	
TA	Operating free-air temperature			- 55		125	0		70	°C	

NOTE 2: This set up time ensures the register will see stable data from the counter outputs. The clocks may be tied together in which case the register state will be one clock pulse behind the counter.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER VIK		TEST CONDITIONS†			SN54LS'			SN74LS'		
				MIN	TYP#	MAX	MIN	TYP‡	MAX	TINU
		V _{CC} = MIN, I _I = - 18 mA				- 1.5			- 1.5	V
	Any Q	V _{CC} = MIN, V _{IH} = 2 V,	I _{OH} = – 1 mA	2.4	3.1					
∨он 📿	Апу О	VIL = MAX	IOH = - 2.6 mA				2.4	3.1		l v
	RCO		IOH = - 0.4 mA	2.5	3.2		2.7	3.2		<u> </u>
	Апу С	Ď.	IOL = 12 mA		0.25	0.4		0.25	0.4	٧
VOL .	Any Q	V _{CC} = MIN, V _{IH} = 2 V,	I _{OL} = 24 mA					0.35	0.5	
*OL	RCO	VIL = MAX	IOL = 4 mA		0.25	0,4		0.25	0.4	
	RCO	I	IOL = 8 mA					0.35	0.5	1
lozh	Any Q	V _{CC} = MAX, V _{IH} = 2 V, V _{IL} = MAX, V _O = 2.7 V				20			20	μА
lozL	Any Q	V _{CC} = MAX, V _{IH} = 2 V, V _{IL} = MAX, V _O = 0.4 V		1		- 20			- 20	μА
4		V _{CC} = MAX, V _I = 7 V				0,1			0.1	mA
lH.		V _{CC} = MAX, V ₁ = 2.7 V		\top		20	1		20	μА
. 1	A thru D	Vcc = MAX, V1 = 0.4 V			_	- 0.4			- 0.4	^
IL.	All others	1 VCC - MAX, V1 - 0.4 V	: 			- û.2			- 0.2	mA
laan l	Any Q	W - MAY W OW		- 30	-	- 130	- 30		- 130	
loss	RCO	V_{CC} = MAX, V_{O} = 0 V		- 20		- 100	- 20		- 100	mΑ
ICCH ICCL ICCZ		V MAY	See Note 3		46	65		46	65	
		V _{CC} = MAX,	See Note 4		48	70		48	70	mA
		All outputs open	See Note 5		48	70		48	70	

 $^{^\}dagger$ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

4. ICCL is measured after two 0-V to 4.5-V to 0-V pulses have been applied to CCK and RCK while all other inputs are grounded.

[‡] All typical values are at V_{CC} = 5 V, T_A = 25°C.

[§] Not more than one output should be shorted at a time and duration of short-circuit should not exceed one second.

NOTES: 3. ICCH is measured after two 4.5 V to 0-V to 4.5-V pulses have been applied to CCK and RCK while G is grounded and all other inputs are at 4.5 V.

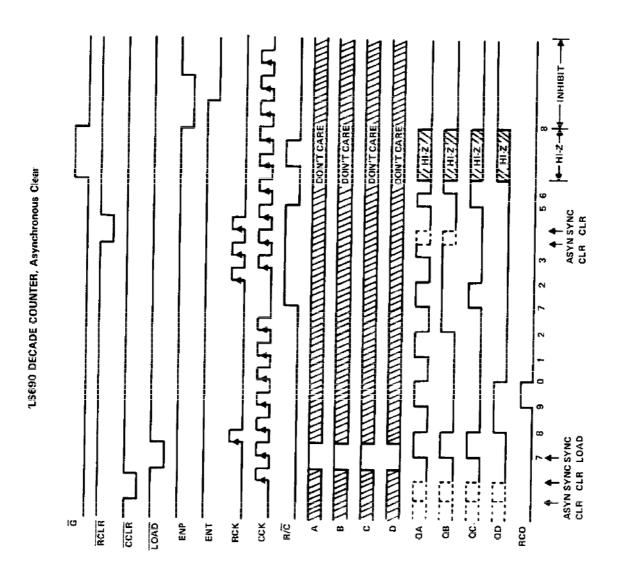
ICCZ is measured after two 0-V to 4.5-V to 0-V pulses have been applied to CCK and RCK while G is at 4.5 V and all other inputs are grounded.

switching characteristics, VCC = 5 V, TA = 25°C (see note 6)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	'LS690, 'L	'L\$			
				MIN TYP	MAX	MIN TY	P MAX	UNIT
tPLH	CCK†	RCO	R _L = 2 kΩ, C _L = 15 pF	23	40	7	23 40	→ ns
†PHL		100		23	40		23 40	
tPLH	ENT	RCO		13	20		3 20	
^t PH <u>L</u>] =:*:	HOO		13	20		3 20	ins ins
[†] PLH	CCK†	a		12	20		2 20	
tPHL .		•		17	25		7 25	ns
†PLH	RCK↑	a	1	12	20		2 20	ns
^t PHL		ų.		17	25		7 25	
[†] PH L	<u>CCLR</u> ↓	Q		23	40			ns
¹₽HL	RCLR↓	Q	Rլ = 667 Ω, C _L = 45 pF	20	30		-	ns
^t PLH	R/C	Q	n	16	25		6 25	
^t PHL] "/"	"		16	25	'"-	6 25	ns
^t PZH	Ğţ	<u>g</u> †		19	30		9 30	
tPZL				19	30		9 30	ns
^t PHZ	Ğ↑	Ō	D R _L = 667 Ω, C _L = 5 pF	17	30		7 30	1
^t PLZ		2		17	30	1	7 30	ns

NOTE 6: Load circuits and voltage waveforms are shown in Section 1.

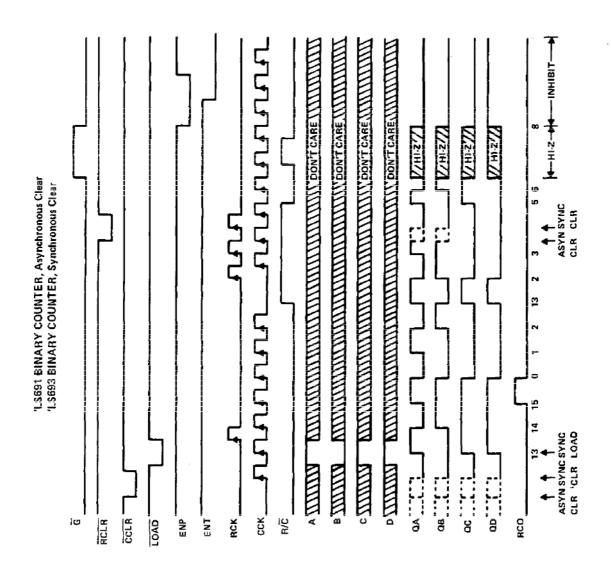
typical operating sequences





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typical operating sequences (continued)



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